

# **Aluminum electrolytic capacitors**

Axial-lead and soldering star capacitors

**Series/Type: B41689, B41789**Date: December 2019

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#### Axial-lead and soldering star capacitors

B41689, B41789

#### Very high ripple current − up to 150 °C

#### **Applications**

Automotive electronics

#### **Features**

- High vibration stability, special design with high vibration stability up to 60 g available upon request
- Very high ripple current capability
- Long useful life, 10000 h at up to 125 °C
- Low ESR also at rated voltage 63 V DC
- SIKOREL design storage for up to 15 years at a temperature of up to 35 °C
- RoHS-compatible



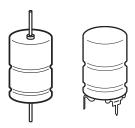
- Charge/discharge-proof, polar
- Aluminum case with PET insulating sleeve
- Negative pole connected to case
- Version without insulating sleeve available upon request

#### **Terminals**

- Axial leads, welded to capacitor case and cover disc
- Soldering star option for upright mounting on PCB or welding to busbar
- Alternative axial-lead design with double-sided plates for horizontal mounting available upon request

#### Taping and packing

- Axial-lead capacitors will be delivered in pallet package Capacitors with  $d \times I \le 16 \times 39$  mm are also available taped on reel
- Soldering star capacitors are packed in blister trays







## Specifications and characteristics in brief

	I								
Rated voltage V <sub>R</sub>	25 63 V DC								
Surge voltage V <sub>s</sub>	**	1.15 · V <sub>R</sub>							
Rated capacitance C <sub>R</sub>	360 4500 μF								
Capacitance tolerance	-10/+30% ≙ Q								
Leakage current I <sub>leak</sub>	C <sub>R</sub> \	$\langle R \rangle_{+4}$							
(5 min, 20 °C)	$  I_{leak} \ge 0.006  \mu A \cdot \sqrt{\mu F} =$	$I_{leak} \le 0.006 \ \mu A \cdot \left(\frac{C_R}{\mu F} \cdot \frac{V_R}{V}\right) + 4 \ \mu A$							
Self-inductance ESL <sup>1)</sup>	Diameter d (mm)		16	18	20	21			
	Terminals	Length I (mi	m) Approx	k. ESL (	nH)				
	axial	25	26	30	_	_			
		29	_	_	38	_			
		30	29	34	-	39			
		35	31	36	_	41			
		39	33	38	_	45			
		49	_	_	_	50			
	soldering star	25	7	8	_	_			
		30	8	10	_	11			
		35	9	10.5	_	12			
		39	9	11		13			
		49	_	_	_	14			
Useful life <sup>2)</sup>		Requiremer	nts:						
150 °C; $V_R$ ; 0.5 · $I_{AC,R}$	> 2000 h <sup>3)</sup>	∆C/C	$\leq$ 30% of	initial va	alue				
125 °C; $V_R$ ; $I_{AC,max}$	> 4000 h	I <sub>leak</sub>	≤ initial sp	ecified	limit				
125 °C; V <sub>R</sub> ; I <sub>AC,R</sub>	> 10000 h	ESR	$\leq$ 3 times	initial sp	pecified	limit <sup>4)</sup>			
Voltage endurance test		Post test re	guirements	S:					
125 °C; V <sub>R</sub>	4000 h for $V_B \le 40 \text{ V DC}$	ΔC/C	≤ 10% of		alue				
, "	3000 h for $V_{R} = 63 \text{ V DC}$	ESR	≤ 1.3 time	s initial	specifie	ed limit <sup>4)</sup>			
		I <sub>leak</sub>	≤ initial sp		•				
Vibration resistance test	To IEC 60068-2-6, test Fo		'						
	Frequency range 10 Hz		acement a	mplitud	e max.	1.5 mm,			
	acceleration max. 20 g, d			·		·			
	Capacitor rigidly clamped			e.g. usi	ng our s	standard			
	fixture.	•		Ü	Ü				
IEC climatic category	To IEC 60068-1: 55/125/5	56 (-55 °C/+	125 °C/56	days da	amp hea	at test)			
Sectional specification	IEC 60384-4	`			•				
Reference standard	AEC-Q200 <sup>5)</sup>								
	1								

<sup>1)</sup> If optimum circuit design is used, the values are lower by 30%.

<sup>2)</sup> Refer to chapter "General technical information, 5 Useful life" on how to interpret useful life.

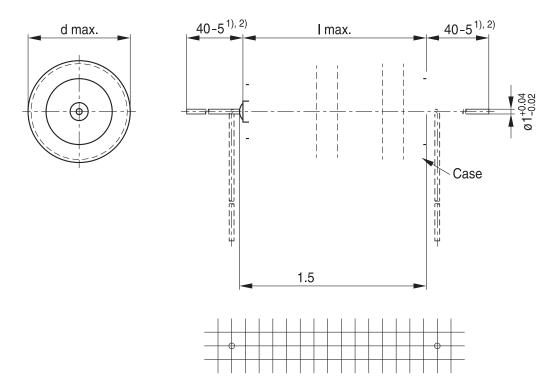
<sup>3)</sup> Continuous operation above 130 °C is limited to a maximum of 100 h per load duration, and it must be followed by a no-load cycle or operation under 130 °C for at least the same duration.

<sup>4)</sup> ESR<sub>max</sub> at 100 Hz, 20  $^{\circ}$ C

<sup>5)</sup> Refer to chapter "General technical information, 2.3 AEC-Q200 standard" for further details.

# B41689, Axial-lead capacitors

# **Dimensional drawing**



KAL1749-V-E

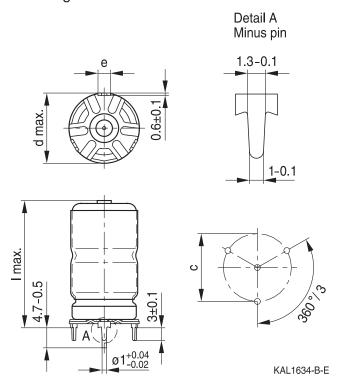






# B41789, Soldering star capacitors Dimensional drawings

Mounting holes d = 16 mm ... 21 mm



#### Dimensions, weights and packing units

$d \times I$	$d_{max} \times I_{max}$	c ±0.1	e ±0.1	Approx. weight	Packing units
mm	mm	mm	mm	g	pcs.
16 × 25	17.5 × 27	16.5	3.0	7.9	300
$16 \times 30$	$17.5 \times 32$	16.5	3.0	9.4	300
$16 \times 35$	$17.5 \times 37$	16.5	3.0	10.9	200
16 × 39	$17.5 \times 41.5$	16.5	3.0	12.2	200
$18 \times 25$	19.5 × 27	18.5	3.0	9.9	300
$18 \times 30$	$19.5 \times 32$	18.5	3.0	11.8	300
$18 \times 35$	$19.5 \times 37$	18.5	3.0	13.2	200
18 × 39	$19.5 \times 41.5$	18.5	3.0	15.4	200
$21 \times 30$	22.5 × 32	21.5	3.5	17.5	468
$21 \times 35$	22.5 × 37	21.5	3.5	18.3	324
21 × 39	22.5 × 41.5	21.5	3.5	21.0	324
21 × 49	22.5 × 51.5	21.5	3.5	26.0	264



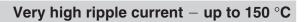


# Very high ripple current - up to 150 $^{\circ}\text{C}$

## Overview of available types

V <sub>R</sub> (V DC)	25	40	63
	Case dimensions	d × I (mm)	•
C <sub>R</sub> (μF)			
360			16 × 25
470			18 × 25
510			16 × 30
560		16 × 25	
620			16 × 35 18 × 30
680		18 × 25	
720		16 × 30	
750			16 × 39
820		16 × 35	18 × 35
900		18 × 30	
910			18 × 39 21 × 30
1000	16 × 25	16 × 39	
1100			21 × 35
1200	18 × 25	20×29	
1300	16 × 30		21 × 39
1400		18 × 39	
1500	16 × 35		
1700	18 × 30		
1800	16 × 39		21 × 49
1900	20 × 29		
2000		21 × 39	
2200	18 × 39		
2700		21 × 49	
3300	21 × 39		
4500	21 × 49		







## Case dimensions and ordering codes

$\overline{C_R}$	Case	Ordering code	Ordering code	Ordering code
120 Hz	dimensions	Axial pallet	Axial reel	Soldering star
20 °C	$d \times I$			
μF	mm			
$V_R = 25 V D$	С			
1000	16 × 25	B41689A5108Q001	B41689A5108Q003	B41789A5108Q001
1000 ∇	16 × 25	B41689K5108Q001	B41689K5108Q003	B41789K5108Q001
1200	18 × 25	B41689A5128Q001		B41789A5128Q001
1200 ∇	18 × 25	B41689K5128Q001		B41789K5128Q001
1300	16 × 30	B41689A5138Q001	B41689A5138Q003	B41789A5138Q001
1300 ∇	16 × 30	B41689K5138Q001	B41689K5138Q003	B41789K5138Q001
1500	16 × 35	B41689A5158Q001	B41689A5158Q003	B41789A5158Q001
1500 ∇	16 × 35	B41689K5158Q001	B41689K5158Q003	B41789K5158Q001
1700	18 × 30	B41689A5178Q001		B41789A5178Q001
1700 ∇	18 × 30	B41689K5178Q001		B41789K5178Q001
1800	16 × 39	B41689A5188Q001	B41689A5188Q003	B41789A5188Q001
1800 ∇	16 × 39	B41689K5188Q001	B41689K5188Q003	B41789K5188Q001
1900	20 × 29	B41689A5198Q001		
1900 ∇	20 × 29	B41689K5198Q001		
2200	18 × 39	B41689A5228Q001		B41789A5228Q001
2200 ∇	18 × 39	B41689K5228Q001		B41789K5228Q001
3300	21 × 39	B41689A5338Q001		B41789A5338Q001
3300 ∇	21 × 39	B41689K5338Q001		B41789K5338Q001
4500	21 × 49	B41689A5458Q001		B41789A5458Q001
4500 ∇	21 × 49	B41689K5458Q001		B41789K5458Q001

 $<sup>\</sup>nabla$  Increased ripple current due to optimized thermal design





Very high ripple current – up to 150 °C

## Case dimensions and ordering codes

$\overline{C_R}$	Case	Ordering code	Ordering code	Ordering code
120 Hz	dimensions	Axial pallet	Axial reel	Soldering star
20 °C	$d \times I$			
μF	mm			
$V_R = 40 \text{ V D}$	С			
560	16 × 25	B41689A7567Q001	B41689A7567Q003	B41789A7567Q001
560 ∇	16 × 25	B41689K7567Q001	B41689K7567Q003	B41789K7567Q001
680	18 × 25	B41689A7687Q001		B41789A7687Q001
680 ∇	18 × 25	B41689K7687Q001		B41789K7687Q001
720	16 × 30	B41689A7727Q001	B41689A7727Q003	B41789A7727Q001
720 ∇	16 × 30	B41689K7727Q001	B41689K7727Q003	B41789K7727Q001
820	16 × 35	B41689A7827Q001	B41689A7827Q003	B41789A7827Q001
820 ∇	16 × 35	B41689K7827Q001	B41689K7827Q003	B41789K7827Q001
900	18 × 30	B41689A7907Q001		B41789A7907Q001
900 ∇	18 × 30	B41689K7907Q001		B41789K7907Q001
1000	16 × 39	B41689A7108Q001	B41689A7108Q003	B41789A7108Q001
1000 ∇	16 × 39	B41689K7108Q001	B41689K7108Q003	B41789K7108Q001
1200	20 × 29	B41689A7128Q001		
1200 ∇	20 × 29	B41689K7128Q001		
1400	18 × 39	B41689A7148Q001		B41789A7148Q001
1400 ∇	18 × 39	B41689K7148Q001		B41789K7148Q001
2000	21 × 39	B41689A7208Q001		B41789A7208Q001
2000 ∇	21 × 39	B41689K7208Q001		B41789K7208Q001
2700	21 × 49	B41689A7278Q001		B41789A7278Q001
2700 ∇	21 × 49	B41689K7278Q001		B41789K7278Q001

 $<sup>\</sup>boldsymbol{\nabla}$  Increased ripple current due to optimized thermal design







## Case dimensions and ordering codes

$\overline{C_R}$	Case	Ordering code	Ordering code	Ordering code
120 Hz	dimensions	Axial pallet	Axial reel	Soldering star
20 °C	d×I	7 Mai pallot	7 (λίαι 100)	Coldoning old
μ <b>F</b>	mm			
$V_R = 63 \text{ V D}$	C			
360	16 × 25	B41689B8367Q001	B41689B8367Q003	B41789B8367Q001
360 ∇	16 × 25	B41689L8367Q001	B41689L8367Q003	B41789L8367Q001
470	18 × 25	B41689B8477Q001		B41789B8477Q001
470 ∇	18 × 25	B41689L8477Q001		B41789L8477Q001
510	16 × 30	B41689B8517Q001	B41689B8517Q003	B41789B8517Q001
510 ∇	16 × 30	B41689L8517Q001	B41689L8517Q003	B41789L8517Q001
620	16 × 35	B41689B8627Q001	B41689B8627Q003	B41789B8627Q001
620	18 × 30	B41689C8627Q001		B41789C8627Q001
620 ∇	16 × 35	B41689L8627Q001	B41689L8627Q003	B41789L8627Q001
620 ∇	18 × 30	B41689M8627Q001		B41789M8627Q001
750	16 × 39	B41689B8757Q001	B41689B8757Q003	B41789B8757Q001
750 ∇	16 × 39	B41689L8757Q001	B41689L8757Q003	B41789L8757Q001
820	18 × 35	B41689B8827Q001		B41789B8827Q001
820 ∇	18 × 35	B41689L8827Q001		B41789L8827Q001
910	18 × 39	B41689B8917Q001		B41789B8917Q001
910	21 × 30	B41689C8917Q001		B41789C8917Q001
910 ∇	18 × 39	B41689L8917Q001		B41789L8917Q001
910 ∇	21 × 30	B41689M8917Q001		B41789M8917Q001
1100	21 × 35	B41689B8118Q001		B41789B8118Q001
1100 ∇	21 × 35	B41689L8118Q001		B41789L8118Q001
1300	21 × 39	B41689B8138Q001		B41789B8138Q001
1300 ∇	21 × 39	B41689L8138Q001		B41789L8138Q001
1800	21 × 49	B41689B8188Q001		B41789B8188Q001
1800 ∇	21 × 49	B41689L8188Q001		B41789L8188Q001

 $<sup>\</sup>nabla$  Increased ripple current due to optimized thermal design





# Very high ripple current - up to 150 $^{\circ}$ C

#### **Technical data**

$\overline{C_R}$	Case	ESR <sub>max</sub>	ESR <sub>max</sub>	ESR <sub>max</sub>	Z <sub>max</sub>	I <sub>AC,max</sub> 1)	I <sub>AC,max</sub>	I <sub>AC,R</sub>	I <sub>AC,max</sub>
120 Hz	dimensions	100 Hz	100 Hz	10 kHz	100 kHz	10 kHz	10 kHz	10 kHz	10 kHz
20 °C	d×I	20 °C	-40 °C	20 °C	20 °C	T <sub>C</sub> 125 °C	125 °C	125 °C	150 °C
μF	mm	mΩ	mΩ	mΩ	mΩ	Α	Α	Α	Α
$V_R = 25 \text{ V}$	DC								
1000	16 × 25	98	565	53	50	9.2	5.7	3.5	1.7
1000 ∇	16 × 25	98	565	53	50	10.1	6.0	3.6	1.8
1200	18 × 25	80	470	43	41	11.1	6.9	4.2	2.1
1200 ∇	18 × 25	80	470	43	41	12.2	7.2	4.4	2.2
1300	16 × 30	75	435	41	39	11.4	7.1	4.3	2.2
1300 ∇	16 × 30	75	435	41	39	12.5	7.4	4.5	2.2
1500	16 × 35	65	377	35	34	13.3	8.3	5.0	2.5
1500 ∇	16 × 35	65	377	35	34	14.6	8.6	5.2	2.6
1700	18 × 30	57	332	31	29	14.1	8.8	5.3	2.7
1700 ∇	18 × 30	57	332	31	29	15.5	9.1	5.5	2.8
1800	16 × 39	55	314	30	28	15.1	9.4	5.7	2.9
1800 ∇	16 × 39	55	314	30	28	16.6	9.8	5.9	3.0
1900	20 × 29	52	297	28	27	14.5	9.1	5.5	2.7
1900 ∇	20 × 29	52	297	28	27	16.0	9.5	5.7	2.9
2200	18 × 39	44	257	24	23	18.3	11.4	6.9	3.4
2200 ∇	18 × 39	44	257	24	23	20.1	11.8	7.2	3.6
3300	21 × 39	31	172	17	16	21.0	13.1	7.9	4.0
3300 ∇	21 × 39	31	172	17	16	23.2	13.6	8.3	4.1
4500	21 × 49	23	126	13	12	26.5	16.5	10.0	5.0
4500 ∇	21 × 49	23	126	13	12	29.2	17.2	10.4	5.2

 $<sup>\</sup>nabla$  Increased ripple current due to optimized thermal design

<sup>1)</sup> Maximum ripple current at 125 °C capacitor case temperature T<sub>C</sub> (measured at aluminum case surface), when mounted to a heat sink. Further details available upon request.

## **Technical data**

C <sub>R</sub>	Case	ESR <sub>max</sub>	ESR <sub>max</sub>	ESR <sub>max</sub>	Z <sub>max</sub>	I <sub>AC,max</sub> <sup>2)</sup>	I <sub>AC,max</sub>	$I_{AC,R}$	I <sub>AC,max</sub>
120 Hz	dimensions	100 Hz	100 Hz	10 kHz	100 kHz	10 kHz	10 kHz	10 kHz	10 kHz
20 °C	d×I	20 °C	-40 °C	20 °C	20 °C	T <sub>C</sub> 125 °C	125 °C	125 °C	150 °C
μF	mm	$m\Omega$	mΩ	mΩ	$m\Omega$	Α	Α	Α	Α

∇ I (10)0**©**Hz

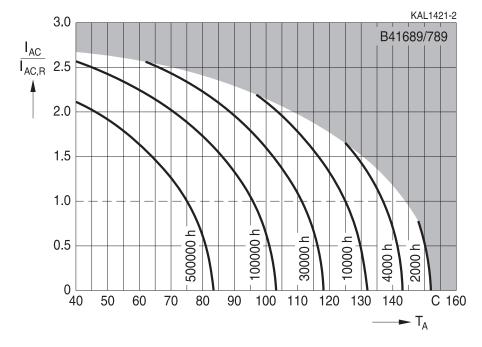
## **Technical data**

C <sub>R</sub>	Case	ESR <sub>max</sub>	ESR <sub>max</sub>	ESR <sub>max</sub>	Z <sub>max</sub>	I <sub>AC,max</sub> <sup>3)</sup>	I <sub>AC,max</sub>	I <sub>AC,R</sub>	I <sub>AC,max</sub>
120 Hz	dimensions	100 Hz	100 Hz	10 kHz	100 kHz	10 kHz	10 kHz	10 kHz	10 kHz
20 °C	d×I	20 °C	-40 °C	20 °C	20 °C	T <sub>C</sub> 125 °C	125 °C	125 °C	150 °C
μF	mm	mΩ	mΩ	mΩ	mΩ	Α	Α	Α	Α
$V_R = 63 \text{ V}$	DC								
360	16 × 25	173	652	58	55	8.9	5.1	3.2	1.6
360 ∇	16 × 25	173	652	58	55	9.2	5.3	3.3	1.6
470	18 × 25	132	499	43	41	11.1	6.3	4.0	2.0
470 ∇	18 × 25	132	499	43	41	11.4	6.6	4.1	2.1
510	16 × 30	124	461	42	40	11.2	6.4	4.0	2.0
510 ∇	16 × 30	124	461	42	40	11.6	6.7	4.2	2.1
620	16 × 35	102	379	34	33	13.4	7.6	4.8	2.4
620	18 × 30	100	379	33	32	13.8	7.9	4.9	2.5
620 ∇	16 × 35	102	379	34	33	13.8	7.9	5.0	2.5
620 ∇	18 × 30	100	379	33	32	14.2	8.2	5.1	2.6
750	16 × 39	84	314	29	27	15.2	8.7	5.5	2.7
750 ∇	16 × 39	84	314	29	27	15.8	9.0	5.6	2.8
820	18 × 35	76	287	26	24	16.6	9.5	6.0	3.0
820 ∇	18 × 35	76	287	26	24	17.2	9.9	6.2	3.1
910	18 × 39	69	•	•	•	•	•	•	•

 $<sup>\</sup>boldsymbol{\nabla}$  Increased ripple current due to optimized thermal design

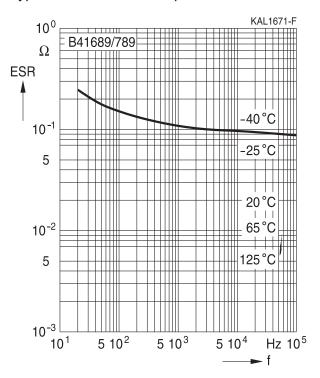
<sup>3)</sup> Maximum ripple current at 125  $^{\circ}$ C capacitor case temperature  $T_{c}$  (measured at aluminum case surface), when mounted to a heat sink. Further details available upon request.

 $\begin{tabular}{l} \textbf{Useful life}^{1)} \\ \textbf{depending on ambient temperature $T_A$ under ripple current operating conditions at $V_R$ } \\ \end{tabular}$ 



# Equivalent series resistance ESR versus frequency f

Typical behavior for 820 μF/63 V



# Impedance Z versus frequency f

Typical behavior for 820 μF/63 V



<	$\supset$



#### **Cautions and warnings**

#### Personal safety

The electrolytes used have been optimized both with a view to the intended application and with regard to health and environmental compatibility. They do not contain any solvents that are detrimental to health, e.g. dimethyl formamide (DMF) or dimethyl acetamide (DMAC). Furthermore, some of the high-voltage electrolytes used are self-extinguishing.

As far as possible, we do not use any dangerous chemicals or compounds to produce operating electrolytes, although in exceptional cases, such materials must be used in order to achieve specific physical and electrical properties because no alternative materials are currently known. We do, however, restrict the amount of dangerous materials used in our products to an absolute minimum.

Materials and chemicals used in our aluminum electrolytic capacitors are continuously adapted in compliance with the TDK Electronics Corporate Environmental Policy and the latest EU regulations and guidelines such as RoHS, REACH/SVHC, GADSL, and ELV.

MDS (Material Data Sheets) are available on our website for all types listed in the data book. MDS for customer specific capacitors are available upon request.

MSDS (Material Safety Data Sheets) are available for our electrolytes upon request.

Nevertheless, the following rules should be observed when handling aluminum electrolytic capacitors: No electrolyte should come into contact with eyes or skin. If electrolyte does come into contact with the skin, wash the affected areas immediately with running water. If the eyes are affected, rinse them for 10 minutes with plenty of water. If symptoms persist, seek medical treatment. Avoid inhaling electrolyte vapor or mists. Workplaces and other affected areas should be well ventilated. Clothing that has been contaminated by electrolyte must be changed and rinsed in water.





# Very high ripple current - up to 150 $^{\circ}\text{C}$

## **Product safety**

The table below summarizes the safety instructions that must be observed without fail. A detailed description can be found in the relevant sections of seperate file chapter "General technical information".

Topic	Safety information	Reference chapter "General technical information"
Polarity	Make sure that polar capacitors are connected with the right polarity.	1 "Basic construction of aluminum electrolytic capacitors"
Reverse voltage	Voltages of opposite polarity should be prevented by connecting a diode.	3.1.6 "Reverse voltage"
Mounting position of screw-terminal capacitors	Screw terminal capacitors must not be mounted with terminals facing down unless otherwise specified.	11.1. "Mounting positions of capacitors with screw terminals"
Robustness of terminals	The following maximum tightening torques must not be exceeded when connecting screw terminals: M5: 2.5 Nm M6: 4.0 Nm	11.3 "Mounting torques"
Mounting of single-ended capacitors	The internal structure of single-ended capacitors might be damaged if excessive force is applied to the lead wires.  Avoid any compressive, tensile or flexural stress.  Do not move the capacitor after soldering to PC board.  Do not pick up the PC board by the soldered capacitor.  Do not insert the capacitor on the PC board with a hole space different to the lead space specified.	11.4 "Mounting considerations for single-ended capacitors"
Soldering	Do not exceed the specified time or temperature limits during soldering.	11.5 "Soldering"
Soldering, cleaning agents	Do not allow halogenated hydrocarbons to come into contact with aluminum electrolytic capacitors.	11.6 "Cleaning agents"
Upper category temperature	Do not exceed the upper category temperature.	7.2 "Maximum permissible operating temperature"
Passive flammability	Avoid external energy, e.g. fire.	8.1 "Passive flammability"





## Very high ripple current - up to 150 °C

Topic	Safety information	Reference chapter "General technical information"
Active flammability	Avoid overload of the capacitors.	8.2 "Active flammability"
Maintenance	Make periodic inspections of the capacitors.  Before the inspection, make sure that the power supply is turned off and carefully discharge the capacitors.  Do not apply excessive mechanical stress to the capacitor terminals when mounting.	10 "Maintenance"
Storage	Do not store capacitors at high temperatures or high humidity. Capacitors should be stored at +5 to +35 °C and a relative humidity of ≤ 75%.	7.3 "Shelf life and storage conditions"
		Reference chapter "Capacitors with screw terminals"
Breakdown strength of insulating sleeves	Do not damage the insulating sleeve, especially when ring clips are used for mounting.	"Screw terminals — accessories"

#### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.





# Very high ripple current - up to 150 $^{\circ}\text{C}$

## Symbols and terms

Symbol	English	German
С	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$C_{s}$	Series capacitance	Serienkapazität
$C_{S,T}$	Series capacitance at temperature T	Serienkapazität bei Temperatur T
$C_f$	Capacitance at frequency f	Kapazität bei Frequenz f
d	Case diameter, nominal dimension	Gehäusedurchmesser, Nennmaß
$d_{max}$	Maximum case diameter	Maximaler Gehäusedurchmesser
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatzserienwiderstand
ESR <sub>f</sub>	Equivalent series resistance at frequency f	Ersatzserienwiderstand bei Frequenz f
$ESR_T$	Equivalent series resistance at temperature T	Ersatzserienwiderstand bei Temperatur T
f	Frequency	Frequenz
1	Current	Strom
$I_{AC}$	Alternating current (ripple current)	Wechselstrom
$I_{AC,RMS}$	Root-mean-square value of alternating current	Wechselstrom, Effektivwert
$I_{AC,f}$	Ripple current at frequency f	Wechselstrom bei Frequenz f
I <sub>AC,max</sub>	Maximum permissible ripple current	Maximal zulässiger Wechselstrom
$I_{AC,R}$	Rated ripple current	Nennwechselstrom
l <sub>leak</sub>	Leakage current	Reststrom
I <sub>leak,op</sub>	Operating leakage current	Betriebsreststrom
1	Case length, nominal dimension	Gehäuselänge, Nennmaß
I <sub>max</sub>	Maximum case length (without terminals and mounting stud)	Maximale Gehäuselänge (ohne Anschlüsse und Gewindebolzen)
R	Resistance	Widerstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_{\text{symm}}$	Balancing resistance	Symmetrierwiderstand
T	Temperature	Temperatur
$\DeltaT$	Temperature difference	Temperaturdifferenz
$T_A$	Ambient temperature	Umgebungstemperatur
$T_C$	Case temperature	Gehäusetemperatur
$T_B$	Capacitor base temperature	Temperatur des Gehäusebodens
t	Time	Zeit
$\Delta t$	Period	Zeitraum
t <sub>b</sub>	Service life (operating hours)	Brauchbarkeitsdauer (Betriebszeit)





# Very high ripple current - up to 150 $^{\circ}\text{C}$

Symbol	English	German
V	Voltage	Spannung
$V_{F}$	Forming voltage	Formierspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_R$	Rated voltage, DC voltage	Nennspannung, Gleichspannung
$V_S$	Surge voltage	Spitzenspannung
$X_{C}$	Capacitive reactance	Kapazitiver Blindwiderstand
$X_L$	Inductive reactance	Induktiver Blindwiderstand
Z	Impedance	Scheinwiderstand
$Z_T$	Impedance at temperature T	Scheinwiderstand bei Temperatur T
$tan \ \delta$	Dissipation factor	Verlustfaktor
λ	Failure rate	Ausfallrate
$\epsilon_0$	Absolute permittivity	Elektrische Feldkonstante
$\epsilon_{r}$	Relative permittivity	Dielektrizitätszahl
ω	Angular velocity; $2 \cdot \pi \cdot f$	Kreisfrequenz; $2 \cdot \pi \cdot f$

## Note

All dimensions are given in mm.



## **Important** notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.



#### Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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